2-103169-3 - ACTIVE

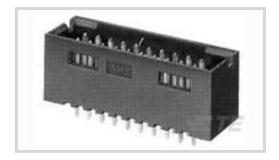
AMPMODU | AMPMODU Headers

TE Internal #: 2-103169-3 PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **50**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Fully Shrouded

Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded						
PCB Mount Orientation	Vertical						
Number of Positions	50						
Number of Rows	2						
Board-to-Board Configuration	Parallel						
Electrical Characteristics							
Insulation Resistance	5000 ΜΩ						
Dielectric Withstanding Voltage (Max)	750 Vrms						
Body Features							
Connector Profile	Standard						
Primary Product Color	Black						
Contact Features							
Mating Square Post Dimension	.64 mm[.025 in]						

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PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]						
Contact Shape & Form	Square						
Contact Underplating Material	Nickel						
PCB Contact Termination Area Plating Material	Tin-Lead						
Contact Base Material	Phosphor Bronze						
Contact Mating Area Plating Material	Gold						
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]						
Contact Type	Pin						
Contact Current Rating (Max)	3 A						
Termination Features							
Square Termination Post & Tail Dimension	.64 mm[.025 in]						
Termination Post & Tail Length	3.18 mm[.125 in]						
Termination Method to Printed Circuit Board	Through Hole - Solder						
Mechanical Attachment							
Mating Retention	With						
Mating Retention Type	Detent Window						
Mating Alignment	With						

Mating Alignment Tura

Delarization

Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal

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PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Industry Standards

Agency/Standard	CSA
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	32
Packaging Type	Tray
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Not Compliant
	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after

handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Wave solder capable to 240°C

Product Compliance Disclaimer

Solder Process Capability

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers





Also in the Series AMPMODU Headers





CB Connector Mounting(1)

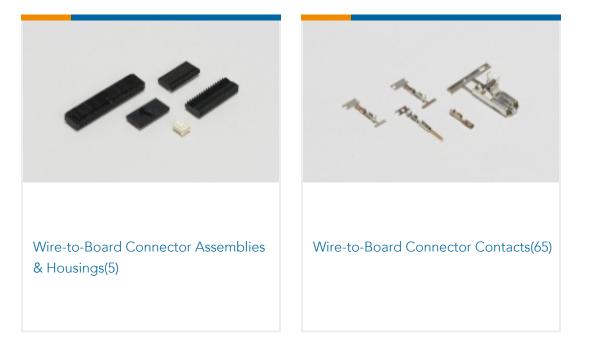


PCR Handors & Pasantaclas(4871)



PCB Latches Locks & Retainers(1)

Connector Caps & Covers(1)	PCB Connector Mounting(1)	PCB Headers & Receptacles(4871)	PCB Latches, Locks & Retainers(1)



Customers Also Bought



PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers







Documents

Product Drawings 50 MODII HDR DRST SHRD .100CL

English

CAD Files **Customer View Model** ENG_CVM_CVM_2-103169-3_N.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-103169-3_N.3d_igs.zip

English

Customer View Model

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ENG_CVM_CVM_2-103169-3_N.3d_stp.zip
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English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English